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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/817,843	03/26/2001	John U. Knickerbocker	END000008US1	9394
7590	12/15/2003		EXAMINER	
Connolly Bove Lodge & Hutz LLP P.O. Box 19088 Washington, DC 20036-3425			ANDUJAR, LEONARDO	
			ART UNIT	PAPER NUMBER
			2826	

DATE MAILED: 12/15/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

<b>Office Action Summary</b>	Application No.	Applicant(s)
	09/817,843	KNICKERBOCKER ET AL.
	Examiner Leonardo Andújar	Art Unit 2826

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --  
**Period for Reply**

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

#### Status

- 1) Responsive to communication(s) filed on 24 September 2003.  
 2a) This action is FINAL.                    2b) This action is non-final.  
 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

#### Disposition of Claims

- 4) Claim(s) 1-3, 17-21 and 35-37 is/are pending in the application.  
 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.  
 5) Claim(s) \_\_\_\_\_ is/are allowed.  
 6) Claim(s) 1-3, 17-21 and 35-37 is/are rejected.  
 7) Claim(s) \_\_\_\_\_ is/are objected to.  
 8) Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

#### Application Papers

- 9) The specification is objected to by the Examiner.  
 10) The drawing(s) filed on \_\_\_\_\_ is/are: a) accepted or b) objected to by the Examiner.  
 Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
 Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).  
 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

#### Priority under 35 U.S.C. §§ 119 and 120

- 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  
 a) All    b) Some \* c) None of:  
 1. Certified copies of the priority documents have been received.  
 2. Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.  
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  
 \* See the attached detailed Office action for a list of the certified copies not received.  
 13) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application) since a specific reference was included in the first sentence of the specification or in an Application Data Sheet. 37 CFR 1.78.  
 a) The translation of the foreign language provisional application has been received.  
 14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121 since a specific reference was included in the first sentence of the specification or in an Application Data Sheet. 37 CFR 1.78.

#### Attachment(s)

- 1) Notice of References Cited (PTO-892)                    4) Interview Summary (PTO-413) Paper No(s). \_\_\_\_\_.  
 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)                    5) Notice of Informal Patent Application (PTO-152)  
 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) \_\_\_\_\_.                    6) Other: \_\_\_\_\_

## DETAILED ACTION

### ***Continued Examination Under 37 CFR 1.114***

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 09/24/2003 has been entered.

### ***Claim Rejections - 35 USC § 102***

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

3. Claims 1-3 and 17-21 are rejected under 35 U.S.C. 102(e) as being anticipated by Elenius et al. (US 6,441,487).

4. Regarding claim 1, Elenius (e.g. figs. 1 and 2) shows an electronic package comprising: a dielectric packaging substrate 22 having a major surface (top surface); and a conductive foil 30 having a smooth portion. The conductive foil is laminated with the substrate major surface. Also, the smooth portion contacts the major surface of the dielectric packaging substrate.

5. Regarding claim 2, Elenius discloses that the conductive foil may comprise aluminum, nickel or copper (col. 7/lls. 1-28).

6. Regarding claim 3, Elenius discloses that the conductive foil may comprise a high electrical conductivity material such as aluminum, nickel, titanium or copper (col. 7/lls. 1-28).

7. Regarding claim 17, Elenius (e.g. figs. 1 and 2) shows an electronic package comprising: a semiconductor packaging substrate 12 having a major surface; a first mechanically compliant dielectric layer 22 formed over the major surface of the substrate and having at least one first opening formed therethrough; a first electrical contact pad 18 formed in the first opening and in electrical contact with the substrate; a second mechanically compliant dielectric layer 24 formed over the first compliant layer and having at least one second opening formed therethrough wherein the second opening is substantially offset from the first opening; a second electrical conductive pad 30 formed in the second opening and extending over a portion of the first electrical contact pad and contacting the first electrical contact pad; a mask layer 32 formed over the second compliant layer and having a third opening therethrough in communication with the second electrical contact pad; and a solder ball 28 solderably connected to the second electrical contact pad and extending through the third opening.

8. Regarding claim 18, Elenius shows that the mask is a solder mask.

9. Regarding claim 19, Elenius shows that the compliant layers can be made of benzocyclobutene. Benzocyclobutene is a photoresist material (e.g. US 6,361,926, col.1/lls. 56-59).

10. Regarding claim 20 and 21, Elenius discloses that the contact pads may comprise aluminum, nickel or copper (col. 7/lls. 1-28).

***Claim Rejections - 35 USC § 103***

11. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

12. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

13. Claims 35-37 are rejected under 35 U.S.C. 103(a) as being obvious over Elenius et al. (US 6,441,487) in view of Gotoh et al. (US 6,204,454).

14. Regarding claims 35 and 36, Elenius shows most aspects of the instant invention including a contact pad laminated surface adhesion. However, Elenius does not disclose the specific roughness of the conductive surface. Gotoh discloses a conductive foil having a roughness in a range of 0.3 to 0.5 microns (col. 7/lls. 9-11). Gotoh discloses that this type of embodiment improves the electrical connection stability

(col. 5/lls. 34-41). It would have been obvious to one of ordinary skill in the art at the time the invention was made to make conductive surface disclosed by Elenius having a roughness in a range of 0.3-0.5 microns in order to improve the electrical connection stability as suggested by Gotoh.

15. Regarding claim 36, Elenius in view of Gotoh does not disclose that the roughness is less than 0.01 microns. However, the specific roughness claimed by applicant, i.e., less than 0.01 microns, absent any criticality, is only considered to be the "optimum" roughness value of the conductive surface disclosed by the Prior Art that a person having ordinary skill in the art would have been able to determine using routine experimentation based, among other things, on the desired accuracy, manufacturing costs, etc. (see *In re Boesch*, 205 USPQ 215 (CCPA 1980)), and since neither non-obvious nor unexpected results, i.e., results which are different in kind and not in degree from the results of the prior art, will be obtained as long as an opening in the housing is used as already suggested by the Prior Art. Note that Gotoh suggest that the surface roughness is a variable that can be subjected to optimization (cols 4-7).

#### ***Response to Arguments***

16. Applicant's arguments filed on 09/24/2003 have been fully considered but they are not persuasive.

17. Applicant argues that Elenius does not show a dielectric packaging substrate because the dielectric substrate 22 disclosed by Elenius is a wafer passivation layer and not a packaging substrate. Although the applicant uses terms different to those of Elenius to label the claimed invention, this does not result in any structural difference

between the claimed invention and the prior art. The use different terminology to describe the plurality of elements that constitute an integrated circuit is just a writing style and the way in which a structural limitation is expressed does not affect the configuration of the described elements. It is respectfully noted that term "packaging" does not imply any specific structural limitation. Although Elenius does not explicitly use the term "packaging" a dielectric packaging substrate 22 is clearly depicted in figure 2. The dielectric substrate 22 is used as a packaging substrate for the retribution layer 30, the passivation layer 32 and the solder bump connection 28. Note that arguments of counsel cannot take the place of factually supported objective evidence. See, e.g., *In re Huang*, 100 F.3d 135, 139-40, 40 USPQ2d 1685, 1689 (Fed. Cir. 1996); *In re De Blauwe*, 736 F.2d 699, 705, 222 USPQ 191, 196 (Fed. Cir. 1984). Furthermore, applicant did not provide any factually supported objective evidence to support his/her position that the term "packaging" excludes dielectric layers such as oxides and resists.

### ***Conclusion***

18. Papers related to this application may be submitted directly to Art Unit 2826 by facsimile transmission. Papers should be faxed to Art Unit 2826 via the Art Unit 2826 Fax Center located in Crystal Plaza 4, room 3C23. The faxing of such papers must conform to the notice published in the Official Gazette, 1096 OG 30 (15 November 1989). The Art Unit 2826 Fax Center number is **(703) 308-7722 or -7724**. The Art Unit 2826 Fax Center is to be used only for papers related to Art Unit 2826 applications.

19. Any inquiry concerning this communication or earlier communications from the examiner should be directed to **Leonardo Andújar** at **(703) 308-0080** and between the

hours of 9:00 AM to 7:30 PM (Eastern Standard Time) Monday through Thursday or by e-mail via Leonardo.Andujar@uspto.gov. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nathan Flynn, can be reached on (703) 308-6601.

20. Any inquiry of a general nature or relating to the status of this application should be directed to the **Group 2800 Receptionist at (703) 305-3900**.

21. The following list is the Examiner's field of search for the present Office Action:

Field of Search	Date
U.S. Class / Subclass (es): 257/690, 691, 698 and 700	12/03
Other Documentation:	
Electronic Database(s): East (USPAT, US PGPUB, JPO, EPO, Derwent, IBM TDB)	12/03

**Leonardo Andújar**  
Patent Examiner Art Unit 2826  
LA  
12/8/03

